

DATASHEET

1.8mm Round Subminiature Chip Phototransistor PT42-21B/TR8



Features

- Fast response time
- High photo sensitivity
- Small junction capacitance
- Package in 12mm tape on 7" diameter reels.
- Ph free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH
- Compliance Halogen Free.(Br<900 ppm,Cl<900 ppm,Br+Cl<1500 ppm)

Descriptions

• PT42-21B/TR8 is a phototransistor in miniature SMD package which is molded in a black plastic with spherical top view lens.

The device is spectrally matched to infrared emitting diode.

Applications

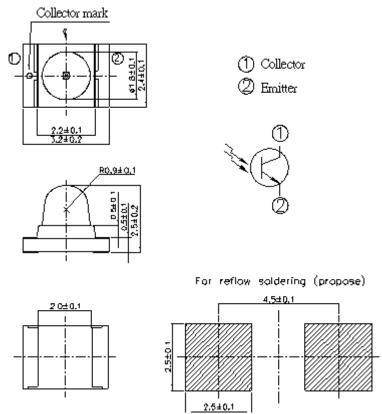
- Miniature switch
- · Counters and sorter
- Position sensor
- Infrared applied system

Device Selection Guide

Part Category	Chip Material	Lens Color
PT	Silicon	Black



Package Dimensions



- Notes: 1.All dimensions are in millimeters
 - 2.Tolerances unless dimensions ±0.1mm
 - 3.Suggested pad dimension is just for reference only
 Please modify the pad dimension based on individual need



Absolute Maximum Ratings (Ta=25°C)

7 1000 id 10 maximum 1 rating (i a = 20 0)							
Parameter	Symbol	Rating	Units				
Collector-Emitter Voltage	or-Emitter Voltage V _{CEO}		V				
Emitter-Collector-Voltage	V _{ECO}	5	V				
Collector Current	Ic	20	mA				
Operating Temperature	T _{opr}	-25 ~ +85	$^{\circ}\!\mathbb{C}$				
Storage Temperature	T _{stg}	-40 ~ +85	$^{\circ}\!\mathbb{C}$				
Soldering Temperature	T _{sol}	260	$^{\circ}\!\mathbb{C}$				
Power Dissipation at(or below)	В	75	mW				
25°ℂ Free Air Temperature	P _d	/5	11100				

Notes: *1:Soldering time \leq 5 seconds.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Rang Of Spectral Bandwidth	λ _{0.5}		730		1100	nm
Wavelength Of Peak Sensitivity	λ_{P}			940		nm
Collector-Emitter Breakdown Voltage	BV _{CEO}	I _C =100μA Ee=0mW/cm²	30			V
Emitter-Collector Breakdown Voltage	BV _{ECO}	I _E =100μA Ee=0mW/cm²	5			\
Collector-Emitter Saturation Voltage	V _{CE(sat)}	I _C =2mA Ee=1mW/cm ²			0.4	V
Collector Dark Current	I _{CEO}	V _{CE} =20V Ee=0mW/cm ²			100	nA
On State Collector Current	I _{C(ON)}	V _{CE} =5V Ee=1mW/cm ²	1.77	3.0		mA



Typical Electro-Optical Characteristics Curves

Fig.1 Spectral Sensitivity

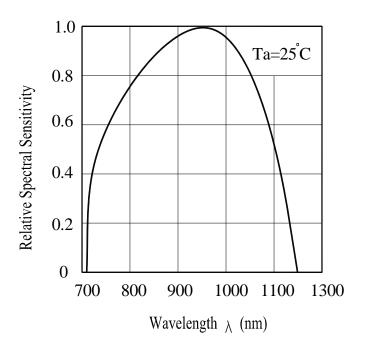


Fig.2 Collector Current vs. Irradiance

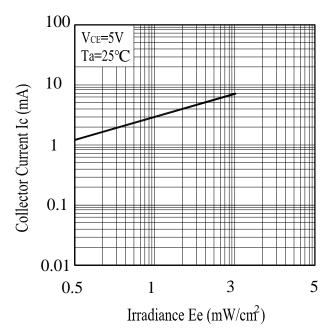
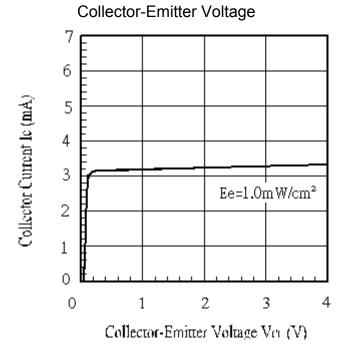


Fig.3 Collector Current vs.





Precautions For Use

1. Over-current-proof

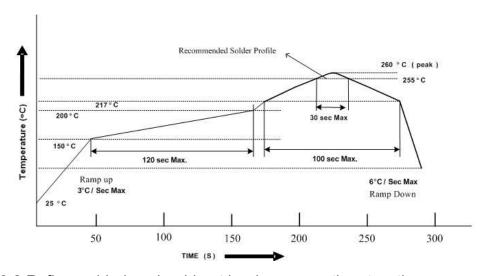
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the Phototransistor should be kept at 10° C \sim 30 $^{\circ}$ C and 90%RH or less.
- 2.3 The Phototransistor suggested be used within one year.
- 2.4 After opening the package, the devices must be stored at 10°C~30°C and ≤ 60%RH, and used within 168 hours (floor life). If unused Phototransistor remain, it should be stored in moisture proof packages.
- 2.5 If the moisture absorbent material (desiccant material) has faded or unopened bag ha exceeded the shelf life or devices (out of bag) have exceeded the floor life, baking treatment is required.
- 2.6 If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the following conditions:
 - 96 hours at 60° C $\pm 5^{\circ}$ C and < 5 % RH (reeled/tubed/loose units)

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the Phototransistor during heating.
- 3.4 After soldering, do not warp the circuit board.

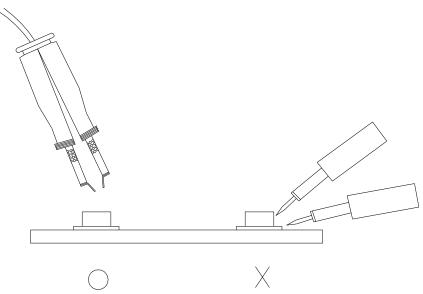


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

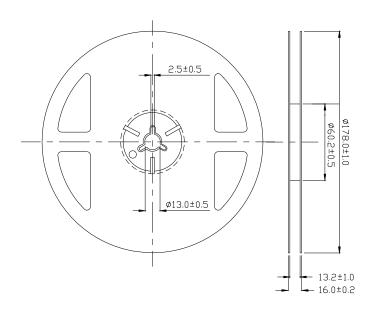
5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



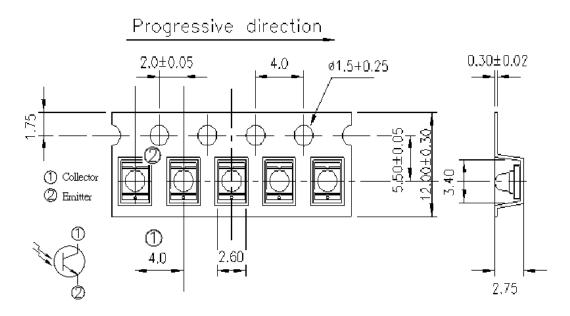


Package Dimensions



Note: The tolerances unless mentioned are ±0.1, unit=mm.

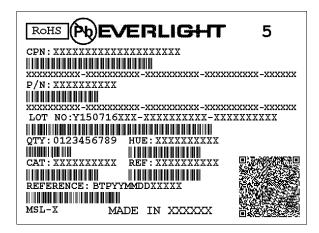
Carrier Tape Dimensions: (Quantity: 1000PCS/Reel)



Note: The tolerances unless mentioned are ±0.1, unit=mm.



Label Form Specification



CPN: Customer's Production Number

P/N : Production Number QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

REF: Reference

LOT No: Lot Number MSL-X: MSL Level

Made In: Manufacture place

Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 3. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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- 5. This product is not intended to be used for military, aircraft, automotive, medical, life sustainingor life saving applications or any other application which can result in human injury or death. Please contact authorized Everlight sales agent for special application request.

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